Preview



N-Channel Super Junction Power MOSFET $\, \mathrm{I\!V}$

General Description

The series of devices use advanced trench gate super junction technology and design to provide excellent R_{DS(ON)} with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

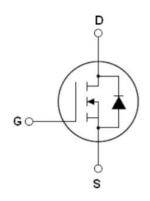
Features

- Optimized body diode reverse recovery performance
- ●Low on-resistance and low conduction losses
- Small package
- ●Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ROHS compliant

Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)
- LLC Half-bridge

V _{DS min@Tjmax}	550	V
R _{DS(ON)TYP} .	1050	mΩ
I_D	3	Α
Qg	4.2	nC



Schematic diagram

Package Marking And Ordering Information

•		
Device	Device Package	Marking
NCE50N1K2K	TO-252-2L	NCE50N1K2K



TO-252

Table 1. Absolute Maximum Ratings (Tc=25℃)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (V _{GS} =0V)	V _{DS}	500	V
Gate-Source Voltage (VDS=0V) ,AC (f>1 Hz)	Vgs	±30	V
Gate-Source Voltage (VDS=0V) ,DC	Vgs	±20	V
Continuous Drain Current at Tc=25°C	I _{D (DC)}	3	Α
Continuous Drain Current at Tc=100°C	I _{D (DC)}	2.1	Α
Pulsed drain current (Note 1)	I _{DM (pluse)}	9	Α
Maximum Power Dissipation(Tc=25℃)	P _D	31	W
Derate above 25°C		0.21	W/°C
Single pulse avalanche current (Note 2)	I _{AS}	1	Α
Reverse diode dv/dt, $V_{DS} \leq 480 \text{ V,I}_{SD} < I_{D}$	dv/dt	15	V/ns
Drain Source voltage slope, V _{DS} ≤480 V	dv/dt	50	V/ns
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55+175	°C



Table 2. Thermal Characteristic

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R _{thJC}	4.84	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R _{thJA}	62	°C /W

 Table 3. Electrical Characteristics (TA=25℃unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
On/off states						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250uA	500			V
Zero Gate Voltage Drain Current(Tc=25°ℂ)	I _{DSS}	V _{DS} =500V,V _{GS} =0V			1	μA
Zero Gate Voltage Drain Current(Tc=125℃)	I _{DSS}	V _{DS} =500V,V _{GS} =0V			50	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS},I_{D}=250uA$	3		4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =1.5A		1050	1200	mΩ
Dynamic Characteristics						
Gate Resistance	Rg	F=1MHZ, D-S short		3.1		Ω
Input Capacitance	C _{lss}	., 50,474 074		120		pF
Output Capacitance	Coss	$V_{DS}=50V, V_{GS}=0V,$		10.5		pF
Reverse Transfer Capacitance	C _{rss}	F=1MHz		4		pF
Total Gate Charge	Qg			4.2	6	nC
Gate-Source Charge	Q _{gs}	V_{DS} =400 V , I_{D} =1.5 A ,		0.5		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V		1.1		nC
Gate plateau voltage	Vgp			5.3		V
Switching times						
Turn-on Delay Time	t _{d(on)}			8		nS
Turn-on Rise Time	tr	V_{DD} =380 V , I_{D} =1.5 A ,		5.5		nS
Turn-Off Delay Time	t _{d(off)}	R_G =4 Ω , V_{GS} =10 V		20		nS
Turn-Off Fall Time	t _f			22		nS
Source- Drain Diode Characteristics						
Source-drain current(Body Diode)	I _{SD}	T 05°0			3	Α
Pulsed-Source-drain current(Body Diode)	I _{SDM}	T _C =25°C			9	Α
Forward on voltage	V _{SD}	Tj=25°C,I _{SD} =3A,V _{GS} =0V		0.9	1.1	V
Reverse Recovery Time	t _{rr}			130		nS
Reverse Recovery Charge	Q _{rr}	$Tj=25^{\circ}C,I_{F=1.5}A,$		0.47		uC
Peak reverse recovery current	I _{rrm}	di/dt=100A/µs		7.2		Α

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. Tj=25 $^{\circ}$ C,VDD=50V,VG=10V, R_G=25 Ω , L=30mH



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure 1. Safe operating area

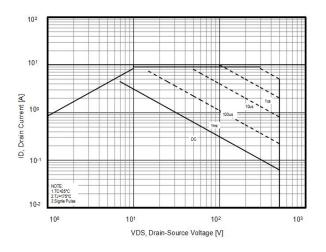


Figure 2. Source-Drain Diode Forward Voltage

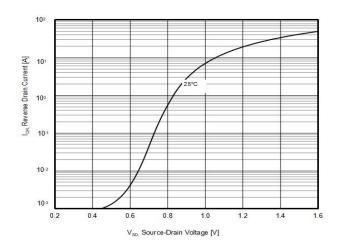


Figure 3. Output characteristics

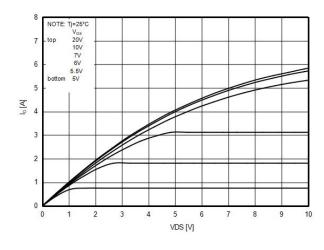


Figure 4. Transfer characteristics

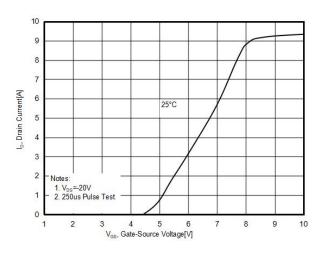


Figure 5. Static drain-source on resistance

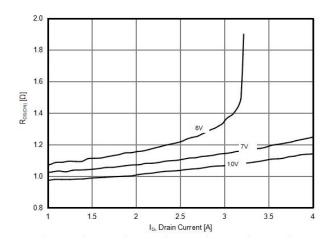
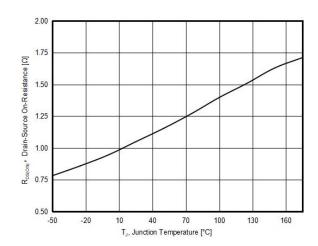


Figure 6. R_{DS(ON)} vs Junction Temperature



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Figure 7. BV $_{\text{DSS}}$ vs Junction Temperature

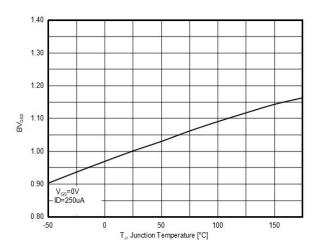


Figure 8. Maximum $I_{\mbox{\scriptsize D}}$ vs Junction Temperature

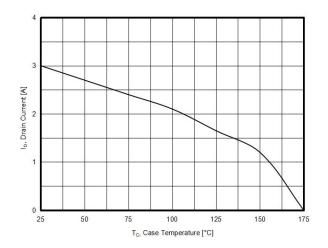


Figure 9. Gate charge waveforms

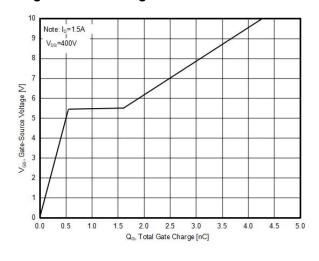
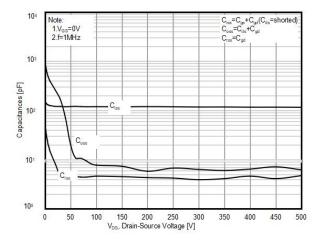


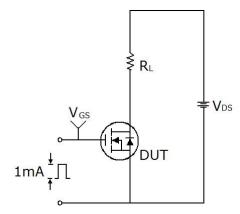
Figure 10. Capacitance

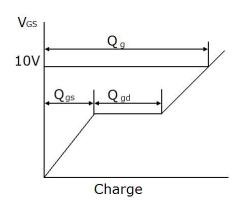




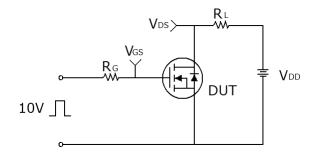
Test circuit

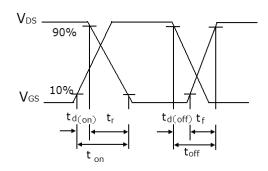
1) Gate charge test circuit & Waveform



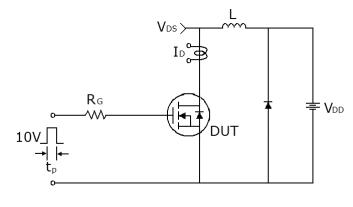


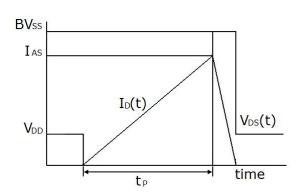
2) Switch Time Test Circuit:





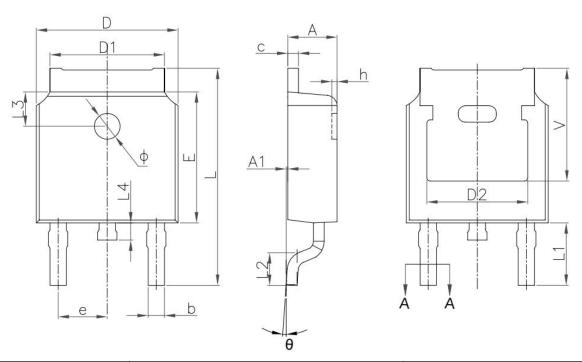
3) Unclamped Inductive Switching Test Circuit & Waveforms







TO-252-2L-E Package Information



Symbol	Dimensions I	n Millimeters	Dimension	s In Inches	
	Min.	Max.	Min.	Max.	
Α	2.20	2.40	0.087	0.094	
A1	0.00	0.13	0.000	0.005	
b	0.66	0.86	0.026	0.033	
b1	0.73	0.79	0.029	0.031	
С	0.46	0.58	0.018	0.023	
c1	0.50	0.52	0.020	0.020	
D	6.50	6.70	0.256	0.264	
D1	5.10	5.46	0.201	0.215	
D2	4.83	REF	0.19REF		
E	6.00	6.20	0.236	0.244	
е	2.19	2.39	0.086	0.094	
L	9.80	10.40	0.386	0.409	
L1	2.90 REF		0.11REF		
L2	1.40	1.70	0.055		
L3	1.60	1.60 REF		REF	
L4	0.60	1.00	0.024	0.039	
Ф	1.10	1.30	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.00	0.30	0.000	0.012	

Preview



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